



TE Internal #: 2-5332095-4
4.52 mm [.178 in] Socket Length, 1.04 mm [.041 in] PCB Hole,
Closed Bottom, .081 – .162 mm² Wire, 28 – 25 AWG, Cable-to-
Board, Pin Sockets
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Connectors > Socket Connectors > Pin Sockets > Mini Spring Sockets: Closed Bottom, 3A



Socket Length: 4.52 mm [.178 in]
PCB Hole Diameter: 1.04 mm [.041 in]
Socket Sleeve Style: Closed Bottom
Wire Size: 28 – 25 AWG

[All Mini Spring Sockets: Closed Bottom, 3A \(10\)](#)

Features

Product Type Features

Connector & Contact Terminates To	Printed Circuit Board
Socket Sleeve Style	Closed Bottom
Connector System	Cable-to-Board
Sealable	No

Configuration Features

Compatible With Wire & Cable Type	Discrete Wire
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Body Features

Sleeve Plating Material	Tin
Sleeve Material	Copper

Contact Features

Contact Spring Plating Material	Gold
Contact Mating Area Plating Material	Gold (Au)
Contact Base Material	Beryllium Copper
Contact Mating Area Plating Material Thickness	30 μm[30 μin]



Contact Spring Plating Thickness	.762 µm[30 µin]
Contact Current Rating (Max)	3 A

Termination Features

Termination Method to PCB	Through Hole - Press-Fit
Termination Method to Wire & Cable	Solder
Insertion Method	Hand/Semi-Automatic

Dimensions

PCB Thickness (Recommended)	.79 – 3.18 mm[.031 – .125 in]
Socket Length	4.52 mm[.178 in]
PCB Hole Diameter	1.04 mm[.041 in]
Wire Size	28 – 25 AWG
Mating Pin Diameter Range	.33 – .51 mm[.013 – .02 in]

Usage Conditions

Operating Temperature Range	-65 – 125 °C[-85 – 257 °F]
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Operation/Application

Solder Process Feature	None
Circuit Application	Power & Signal

Packaging Features

Packaging Method	Bag, Loose Piece
Packaging Quantity	2000

Other

Spring Material	Beryllium Copper
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Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2022 (224) Does not contain REACH SVHC



Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Pin-in-Paste capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) ‘Guidance on requirements for substances in articles’ posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts

TE Part # CAT-377-MSSKB3
Miniature Spring Sockets: Knockout Bottom Beryllium Copper, 3A

Customers Also Bought

TE Part #2007464-1
SFP+ 1x1 Cage Assy, PF,with Heatsink

TE Part #1676235-2
RN 0805 1K54 0.1% 10PPM 1KRL

TE Part #1888968-2
Cage Assy SAN Hsink QSFP Behind Bezel

TE Part #1879208-8
CPF 0402 20R 0.1% 25PPM 1K RL

TE Part #9-2176474-2
RA73F 1J 4K87 0.1% 1K RL

TE Part #2007625-1
1x4 QSFP Kit Assy Bhnd Bzl,PCI

TE Part #4-2176237-2
CPF A 0603 10K 0.1% 25PPM 5K RL

TE Part #1888968-1
Cage Assy PCI Hsink QSFP Behind Bezel



Documents

Product Drawings

SOCKET,MIN-SPR SN-AU SER-1

English

CAD Files

Customer View Model

ENG_CVM_2-5332095-4_O.3d_igs.zip

English

Customer View Model

ENG_CVM_2-5332095-4_O.3d_stp.zip

English

Customer View Model

ENG_CVM_2-5332095-4_O.2d_dxf.zip

English

3D PDF

English

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Product Specifications

Product Specification

English